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December 2010

# **FDT86246**

# N-Channel Power Trench<sup>®</sup> MOSFET 150 V, 2 A, 236 m $\Omega$

#### **Features**

- Max  $r_{DS(on)}$  = 236 m $\Omega$  at  $V_{GS}$  = 10 V,  $I_D$  = 2 A
- $\blacksquare$  Max  $r_{DS(on)}$  = 329 m $\Omega$  at  $V_{GS}$  = 6 V,  $I_D$  = 1.7 A
- High performance trench technology for extremely low r<sub>DS(on)</sub>
- High power and current handling capability in a widely used surface mount package
- Fast switching speed
- 100% UIL Tested
- RoHS Compliant



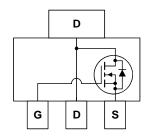
#### **General Description**

This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced Power Trench® process that has been optimized for  $r_{DS(on)}$ , switching performance and ruggedness.

#### **Applications**

- Load Switch
- Primary Switch





## MOSFET Maximum Ratings T<sub>A</sub> = 25 °C unless otherwise noted

Symbol	Parameter		Ratings	Units
$V_{DS}$	Drain to Source Voltage		150	V
$V_{GS}$	Gate to Source Voltage		±20	V
	Drain Current -Continuous	(Note 1a)	2	^
ID	-Pulsed		8	A
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 3)	8	mJ
D	Power Dissipation	(Note 1a)	2.2	W
$P_{D}$	Power Dissipation	(Note 1b)	1.0	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	12	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	55	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
86246	FDT86246	SOT-223	13 "	12 mm	2500 units

# **Electrical Characteristics** $T_J = 25$ °C unless otherwise noted

Symbol	Parameter Test Conditions		Min	Тур	Max	Units
Off Chara	acteristics					
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	150			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D$ = 250 $\mu$ A, referenced to 25 °C		104		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 120 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

#### On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	3.1	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I <sub>D</sub> = 250 μA, referenced to 25 °C		-9		mV/°C
		V <sub>GS</sub> = 10 V, I <sub>D</sub> = 2 A		194	236	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 1.7 \text{ A}$		231	329	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 2 \text{ A}, T_J = 125 °C$		349	425	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 10 \text{ V}, I_{D} = 2 \text{ A}$		5		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	75 77 77 0 77	161	215	pF
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 75 V, V <sub>GS</sub> = 0 V, f = 1 MHz	21	30	pF
C <sub>rss</sub>	Reverse Transfer Capacitance	t = 1 MHz	1.6	5	pF
$R_g$	Gate Resistance		0.9		Ω

## **Switching Characteristics**

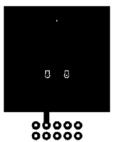
	•					
t <sub>d(on)</sub>	Turn-On Delay Time			7.8	16	ns
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 75 V, I <sub>D</sub> = 2 A,		2.3	10	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$		4.6	10	ns
t <sub>f</sub>	Fall Time			1.2	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V		2.9	4	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V}$ $V_{DD} = 75 \text{ V},$ $I_{D} = 2 \text{ A}$		1.7	3	
Q <sub>gs</sub>	Total Gate Charge	$I_D = 2 A$		0.9		nC
$Q_{ad}$	Gate to Drain "Miller" Charge			0.8		nC

#### **Drain-Source Diode Characteristics**

$V_{SD}$	Source to Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_{S} = 2 \text{ A}$	(Note 2)	0.84	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 2 A, di/dt = 100 A/μs		44	71	ns
Q <sub>rr</sub>	Reverse Recovery Charge			31	49	nC

#### NOTES

<sup>1.</sup>  $R_{\theta JA}$  is determined with the device mounted on a 1 in 2 pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\theta JC}$  is guaranteed by design while  $R_{\theta CA}$  is determined by the user's board design.



a) 55 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 118 °C/W when mounted on a minimum pad of 2 oz copper

<sup>2.</sup> Pulse Test: Pulse Width < 300  $\mu\text{s},$  Duty cycle < 2.0%.

<sup>3.</sup> Starting T  $_J$  = 25 °C; N-ch: L = 1.0 mH, I  $_{AS}$  = 4.0 A, V  $_{DD}$  = 135 V, V  $_{GS}$  = 10 V.

### Typical Characteristics T<sub>J</sub> = 25 °C unless otherwise noted

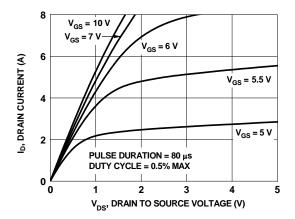


Figure 1. On-Region Characteristics

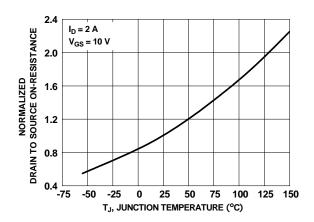


Figure 3. Normalized On-Resistance vs Junction Temperature

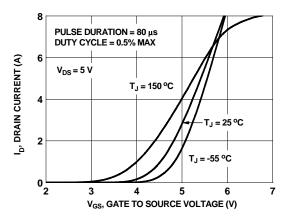


Figure 5. Transfer Characteristics

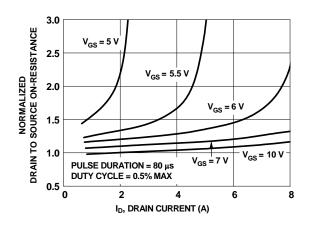


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

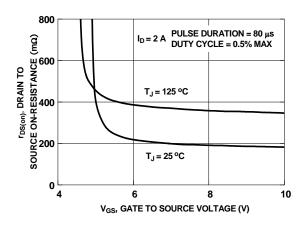


Figure 4. On-Resistance vs Gate to Source Voltage

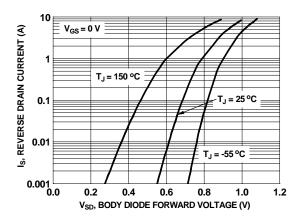


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

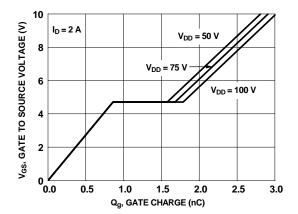


Figure 7. Gate Charge Characteristics

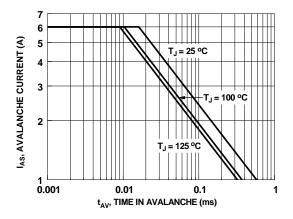


Figure 9. Unclamped Inductive Switching Capability

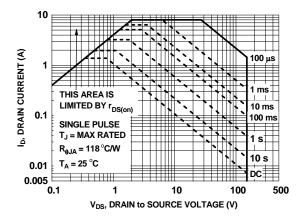


Figure 11. Forward Bias Safe Operating Area

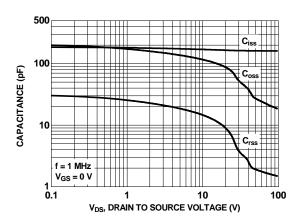


Figure 8. Capacitance vs Drain to Source Voltage

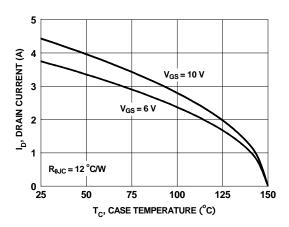


Figure 10. Maximum Continuous Drain Current vs Case Temperature

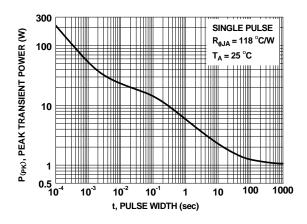


Figure 12. Single Pulse Maximum Power Dissipation

# **Typical Characteristics** $T_J = 25$ °C unless otherwise noted

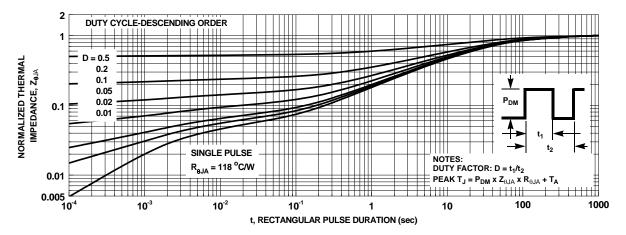
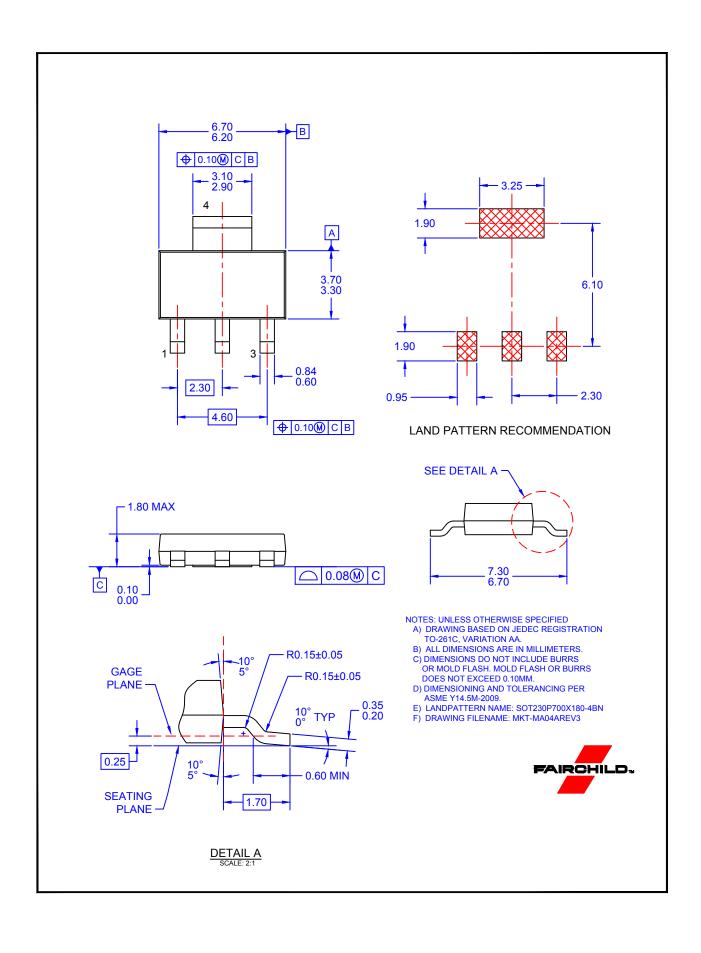


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



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